SCOPE:

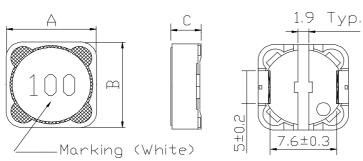
This specification applies to the Pb Free high current type SMD inductors for **MSCDRI-1210-SERIES**

PRODUCT INDENTIFICATION

MSCDRI-1210- 100 M

- 1
- 3 4
- **1** Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 12.0±0.5 mm B: 12.0±0.5 mm C: 10.0 Max. mm

(2) ELECTRICAL SPECIFICATIONS **SEE TABLE 1**

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature +60°C Max.

(3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range -40% \sim +125%



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current	Morking	
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC(A)	Marking	
MSCDRI-1210-1R3□	1.3	N	100kHz/0.1V	3.8m	21.0	1R3	
MSCDRI-1210-2R0□	2.0	N	100kHz/0.1V	4.4m	18.0	2R0	
MSCDRI-1210-2R6□	2.6	N	100kHz/0.1V	7.0m	15.0	2R6	
MSCDRI-1210-3R6	3.6	N	100kHz/0.1V	7.5m	12.5	3R6	
MSCDRI-1210-4R7□	4.7	N	100kHz/0.1V	8.0m	11.5	4R7	
MSCDRI-1210-5R8	5.8	N	100kHz/0.1V	10.0m	10.5	5R8	
MSCDRI-1210-6R8	6.8	M,N	100kHz/0.1V	11.5m	10.0	6R8	
MSCDRI-1210-100□	10	M,N	100kHz/0.1V	17.0m	8.2	100	
MSCDRI-1210-120	12	M,N	100kHz/0.1V	18.5m	7.6	120	
MSCDRI-1210-150□	15	M,N	100kHz/0.1V	25.0m	5.8	150	
MSCDRI-1210-850□	85	M,N	100kHz/0.1V	0.130	2.8	850	
MSCDRI-1210-101□	100	М	100kHz/0.1V	0.150	2.4	101	
MSCDRI-1210-151□	150	М	100kHz/0.1V	0.220	2.0	151	
MSCDRI-1210-221	220	М	100kHz/0.1V	0.257	1.6	221	

[※] ☐ specify the inductance tolerance,M(±20%),N(±30%)



 $[\]gg$ IDC : Based on inductance change (\triangle L/Lo : \leq drop 25%) and @ambient temperature 25°C Based on temperature rise (\triangle T : 45°C TYP.)

(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		in figure 1 and a load applied unitil the figure in the arrow		
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)		
	no mechanical	PCB dimension shall the page 7/9		
	damage or elec-	F(Pressurization)		
	trical damege.	\Box		
		R5 45±2 45±2 10 20 R340		
		PRESSURE ROD figure-1		
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board		
		and when a vibration having an amplitude of 1.52mm		
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should		
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.		
	damage.	(A total of 6 hours)		
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated		
	More than 90%	over the whole of the sample before hard, the sample shall		
		then be preheated for about 2 minutes in a temperature of		
		130∼150℃ and after it has been immersed to a depth 0.5mm		
		below for 3±0.2 seconds fully in molten solder M705 with		
		a temperature of 245±5°C. More than 90% of the electrode sections shall be couered		
		with new solder smoothly when the sample is taken out of		
		the solder bath.		



MECHANICAL

SPECIFICATION				
There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 260±3°C 10 sec Pre-heating Slow cooling (Stored at room temperature) The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.			
	no damage or			

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than 1 × $10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/°C	an ambient temperature of -20 to +85°C ,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM		SPECIFICATION						
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with						
storage		a temperature	a temperature of 85±2℃ and a normal humidity.					
	There shall be	Upon complet	Upon completion of the measurement shall be made after the					
	no mechanical	sample has been left in a normal temperature and normal						
	damage.	humidity for 1	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The sample sh	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a temperature	a temperature of -25±3℃.					
	There shall be	Upon complet	Upon completion of the test, the measurement shall be made					
	no mechanical	after the samp	after the sample has been left in a normal temperature and normal humidity for 1 hour.					
	damage.	normal humid						
Change of	∆L/Lo≦±5%	The sample sh	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the table 2 l	in the table 2 below and then it shall be subjected to standard					
	There shall be	atmospheric o	atmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be made	shall be made.					
	ge of problems							
			table 2					
			Temperature	Duration				
		1	−25±3 °C	30 min.				
			(Themostat No.1)	00				
		2	Standard	N. 4. N. O				
			atmospheric	No.1→No.2				
		3	85±2℃	30 min.				
			(Themostat No.2)					
		4	Standard	N. O. N. 4				
			atmospheric	No.2→No.1				
Moisture storage	∆ I /I o< ±59/	The sample st	nall be left for 96±4 hours	e in a tomporature of				
Moisture Storage	∆L/Lo≦±5%	•		•				
	There shall be	40±2°C and a humidity(RH) of 90∼95%. Upon completion of the test, the measurement shall be made						
	no mechanical							
	damage.	after the sample has been left in a normal temperature and normal humidity more than 1 hour.						
Test conditions :	adinago.		., man i noui.					
	sample shall be reflow	v soldered onto t	he printed circuit board	in every test				
i iie s	ampie shall be reliev	T SOIGCI GU UIILU L	printou on out board	0701 y 1031.				



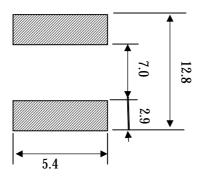
(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

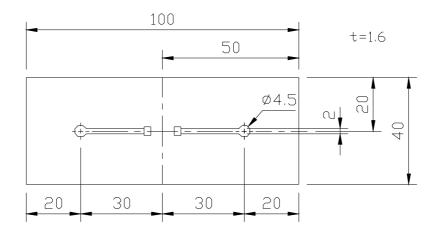
(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN)

Unit:mm

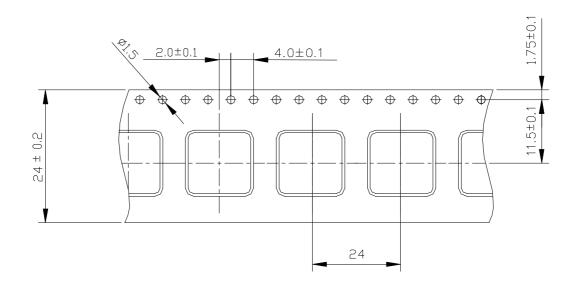


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



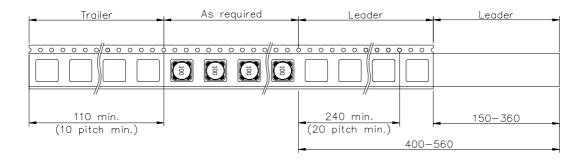
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

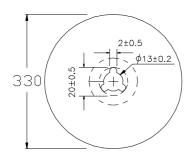


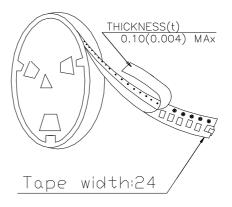
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

250pcs/Reel

The products are packaged so that no damage will be sustained.